Small Signal Schottky Diode

FEATURES

- Integrated protection ring against static discharge
- Very low forward voltage
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT

HALOGEN FREE

DESIGN SUPPORT TOOLS click logo to get started

3D Models Available

APPLICATIONS

- Applications where a very low forward voltage is required

MECHANICAL DATA

Case: MicroMELF

Weight: approx. 12 mg

Cathode band color: black

Packaging codes/options:

TR3/10K per 13" reel (8 mm tape), 10K/box

TR/2.5K per 7" reel (8 mm tape), 12.5K/box

PARTS TABLE

PART	TYPE DIFFERENTIATION	ORDERING CODE	CIRCUIT CONFIGURATION	REMARKS
BAS385	V_R = 30 V	BAS385-TR3 or BAS385-TR	Single	Tape and reel

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V_R	30	V
Peak forward surge current	t_p = 10 ms	I_{FSM}	5	A
Repetitive peak forward current	$t_p \leq 1$ s	I_{FRM}	300	mA
Forward continuous current		I_F	200	mA
Average forward current	V_{RWM} = 25 V	I_{FAV}	200	mA

THERMAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Junction to ambient air	On PC board 50 mm x 50 mm x 1.6 mm	R_{thJA}	320	K/W
Junction temperature		T_j	125	°C
Storage temperature range		T_{stg}	-65 to +150	°C

ELECTRICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I_F = 0.1mA	V_F			240	mV
	I_F = 1 mA	V_F			320	mV
	I_F = 10 mA	V_F			400	mV
	I_F = 30 mA	V_F			500	mV
	I_F = 100 mA	V_F			800	mV
Reserve current	V_R = 25 V, t_p = 300 µs	I_R			2.3	µA
Diode capacitance	V_R = 1 V, f = 1 MHz	C_D			10	pF

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

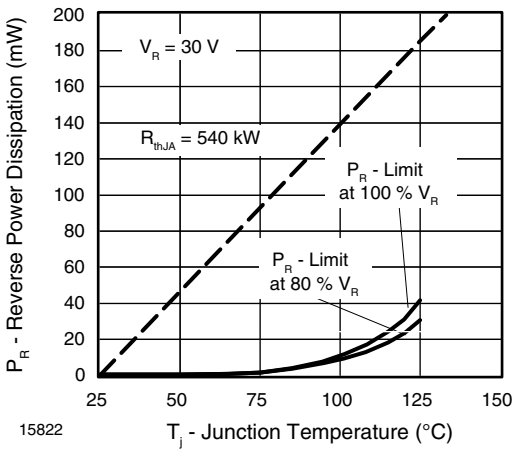


Fig. 1 - Max. Reverse Power Dissipation vs. Junction Temperature

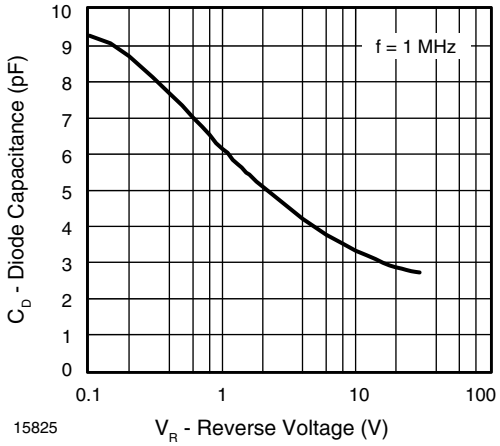


Fig. 4 - Diode Capacitance vs. Reverse Voltage

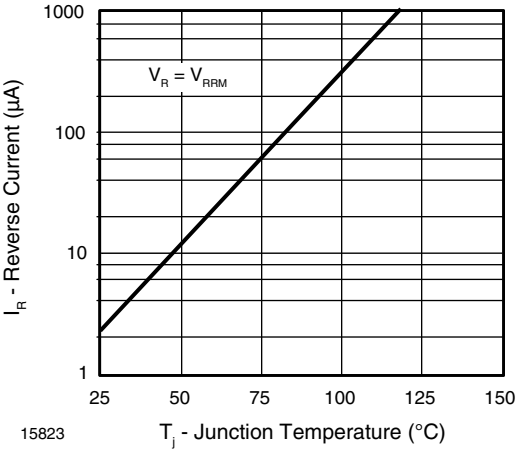


Fig. 2 - Reverse Current vs. Junction Temperature

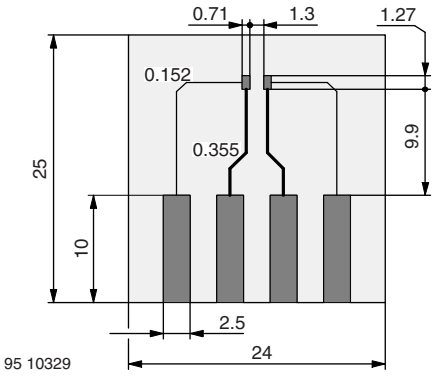


Fig. 5 - Board for R_{thJA} Definition (in mm)

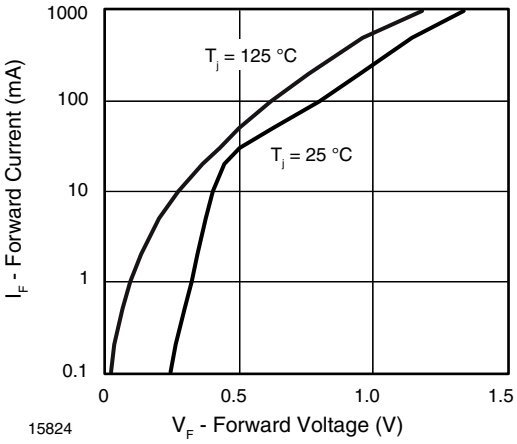
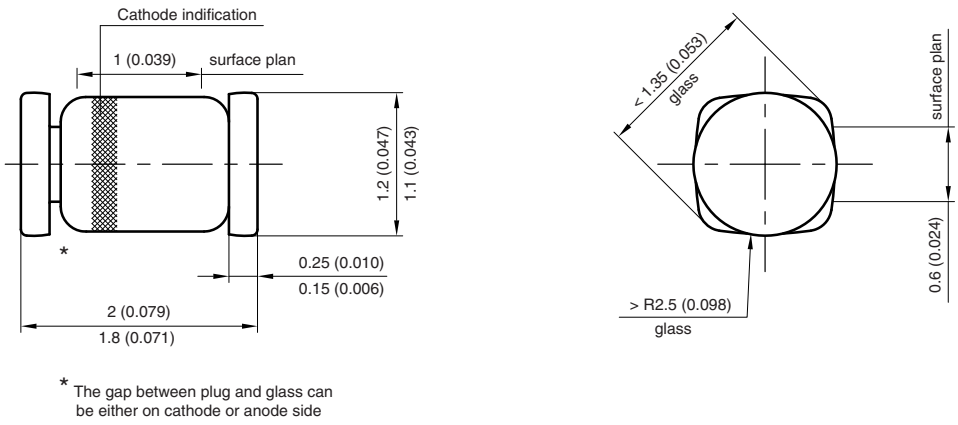


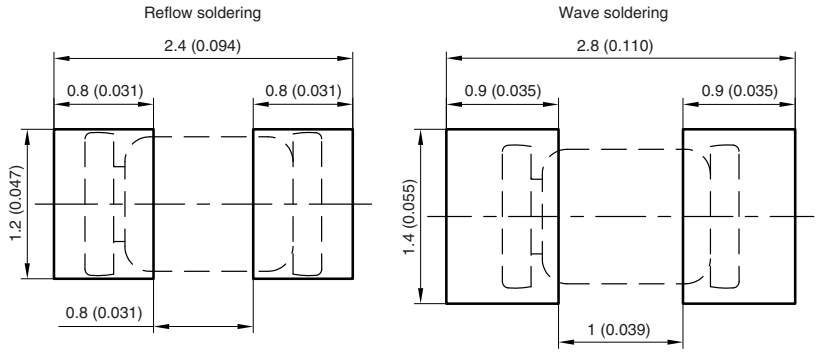
Fig. 3 - Forward Current vs. Forward Voltage

PACKAGE DIMENSIONS in millimeters (inches): **MicroMELF**



* The gap between plug and glass can be either on cathode or anode side

Foot print recommendation:



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